

**Schematic Key for Multilayer and HDI-Technology Build-Ups**

a	b	c	d	e	f	g + h + i
---	---	---	---	---	---	-----------

**04 266 FR4 35 L108.35 P18**

columns and equal kind of positions are separated by "\_". Equal prefixes in one column are reduced to one.

**04\_266\_FR4\_35\_L108.35\_p18**

Layers	in $\mu$	Material	Build-Up	Assembly
<b>Layer-1</b>	35 $\mu$	Copper	 (180 $\mu$ PrePreg-Type: 7628)	 A1 B
	180 $\mu$	Prepreg		
	180 $\mu$	Prepreg		
	180 $\mu$	Prepreg		
	180 $\mu$	Prepreg		
<b>Layer-2</b>	35 $\mu$	Copper		
	1080 $\mu$	L-FR4		
<b>Layer-3</b>	35 $\mu$	Copper		
	180 $\mu$	Prepreg		
	180 $\mu$	Prepreg		
	180 $\mu$	Prepreg		
	180 $\mu$	Prepreg		
<b>Layer-99</b>	35 $\mu$	Copper		

© Copyright by Printed Circuit Boards GmbH